

CD4019B Types

CMOS Quad AND/OR Select Gate

High-Voltage Types (20-Volt Rating)

The RCA-CD4019B types consist of four AND/OR select gate configurations, each consisting of two 2-input AND gates driving a single 2-input OR gate. Selection is accomplished by control bits K_A and K_B . In addition to selection of either channel A or channel B information, the control bits can be applied simultaneously to accomplish the logical A + B function.

The CD4019B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), 16-lead ceramic flat packages (K suffix), and in chip form (H suffix).

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

(Voltages referenced to V_{SS} Terminal) -0.5 to +20 V

INPUT VOLTAGE RANGE, ALL INPUTS

..... -0.5 to V_{DD} +0.5 V

DC INPUT CURRENT, ANY ONE INPUT

..... ± 10 mA

POWER DISSIPATION PER PACKAGE (PD):

For $T_A = -40$ to $+60^\circ\text{C}$ (PACKAGE TYPE E) 500 mW

For $T_A = +60$ to $+85^\circ\text{C}$ (PACKAGE TYPE E) Derate Linearly at 12 mW/ $^\circ\text{C}$ to 200 mW

For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPES D, F, K) 500 mW

For $T_A = +10$ to $+125^\circ\text{C}$ (PACKAGE TYPES D, F, K) Derate Linearly at 12 mW/ $^\circ\text{C}$ to 200 mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR:

For $T_A = \text{FULL PACKAGE TEMPERATURE RANGE}$ (All Package Types) 100 mW

OPERATING-TEMPERATURE RANGE (T_A):

PACKAGE TYPES D, F, K, H -55 to $+125^\circ\text{C}$

PACKAGE TYPE E -40 to $+85^\circ\text{C}$

STORAGE TEMPERATURE RANGE (T_{STG}):

-65 to $+150^\circ\text{C}$

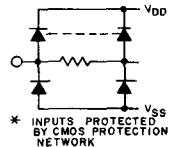
LEAD TEMPERATURE (DURING SOLDERING):

At distance $1/16 \pm 1/32$ inch (1.59 ± 0.79 mm) from case for 10 s max. +265°C

TRUTH TABLE

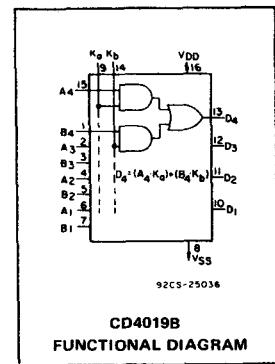
K_A	K_B	A_n	B_n	D_n
1	0	1	X	1
1	0	0	X	0
0	1	X	1	1
0	1	X	0	0
0	0	X	X	0
1	1	0	0	0
1	1	0	1	1
1	1	1	0	1
1	1	1	1	1

X = Don't Care



Features:

- Medium-speed operation
- ... $t_{PHL} = t_{PLH} = 60$ ns (typ.) at $C_L = 50$ pF, $V_{DD} = 10$ V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) = 1 V at $V_{DD} = 5$ V
2 V at $V_{DD} = 10$ V
2.5 V at $V_{DD} = 15$ V

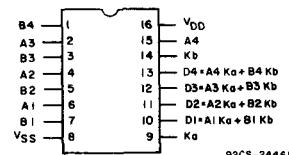


Applications:

- AND-OR select gating
- Shift-right/shift-left registers
- True/complement selection
- AND/OR/Exclusive-OR selection

TERMINAL DIAGRAM

Top View



RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	V_{DD} (V)	Min.	Max.	Units
Supply-Voltage Range (For $T_A = \text{Full Package Temperature Range}$)	-	3	18	V

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Fig. 1—Logic diagram.

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STATIC ELECTRICAL CHARACTERISTICS

CHARAC- TERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)								U N I T S		
	V_O (V)	V_{IN} (V)	V_{DD} (V)	-55				-40		+85		+125		
				Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.		
Quiescent Device Current, I_{DD} Max.	—	0.5	5	1	1	30	30	—	0.02	1	—	—	μA	
	—	0.10	10	2	2	60	60	—	0.02	2	—	—		
	—	0.15	15	4	4	120	120	—	0.02	4	—	—		
	—	0.20	20	20	20	600	600	—	0.04	20	—	—		
Output Low (Sink) Current I_{OL} Min.	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	—	—	—	mA	
	0.5	0.10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	—	—		
	1.5	0.15	15	4.2	4	2.8	2.4	3.4	6.8	—	—	—		
Output High (Source) Current, I_{OH} Min.	4.6	0.5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	—	—	mA	
	2.5	0.5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—	—	—		
	9.5	0.10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—	—	—		
	13.5	0.15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—	—	—		
Output Voltage: Low-Level, V_{OL} Max.	—	0.5	5	0.05				—	0	0.05	—	—	V	
	—	0.10	10	0.05				—	—	0.05	—	—		
	—	0.15	15	0.05				—	0	0.05	—	—		
Output Voltage: High-Level, V_{OH} Min.	—	0.5	5	4.95				4.95	5	—	—	—	V	
	—	0.10	10	9.95				9.95	10	—	—	—		
	—	0.15	15	14.95				14.95	15	—	—	—		
Input Low Voltage, V_{IL} Max.	0.5,4.5	—	5	1.5				—	—	1.5	—	—	V	
	1.9	—	10	3				—	—	3	—	—		
	1.5,13.5	—	15	4				—	—	4	—	—		
Input High Voltage, V_{IH} Min.	0.5,4.5	—	5	3.5				3.5	—	—	—	—	V	
	1.9	—	10	7				7	—	—	—	—		
	1.5,13.5	—	15	11				11	—	—	—	—		
Input Current I_{IN} Max.	—	0.18	18	± 0.1	± 0.1	± 1	± 1	—	$\pm 10^{-5}$	± 0.1	μA	—	—	

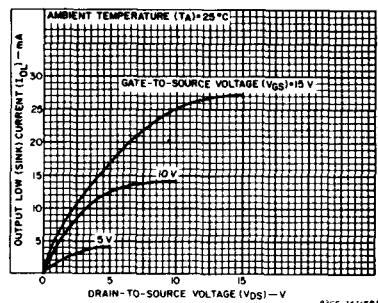


Fig. 2 – Typical output low (sink) current characteristics.

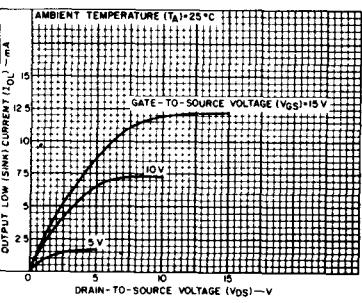


Fig. 3 – Minimum output low (sink) current characteristics.

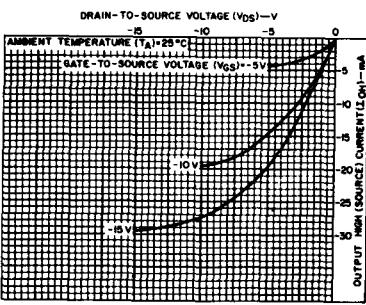


Fig. 4 – Typical output high (source) current characteristics.

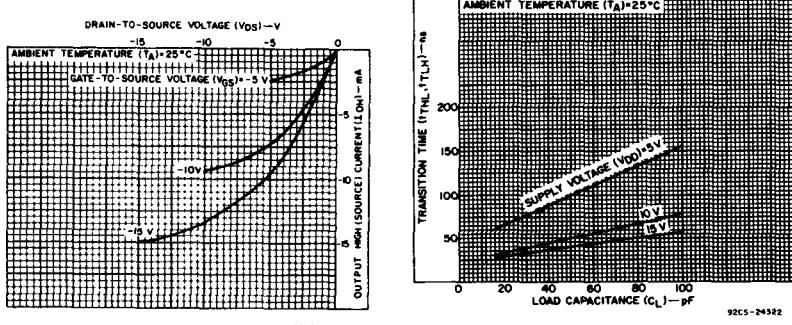


Fig. 5 – Minimum output high (source) current characteristics.

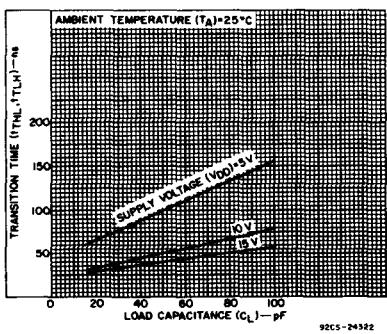


Fig. 6 – Typical transition time as a function of load capacitance.

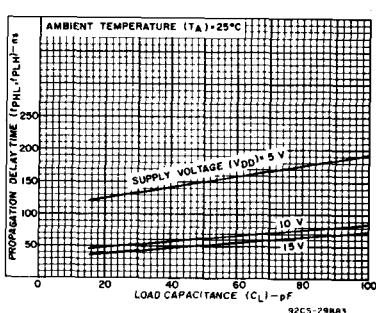
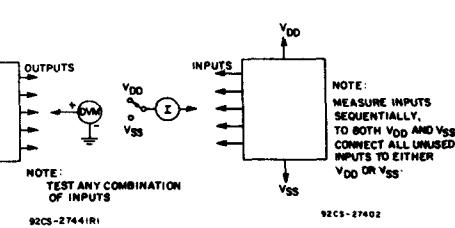
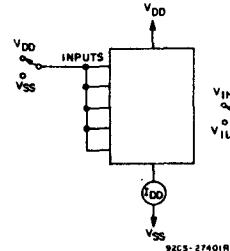
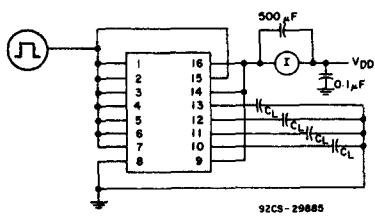
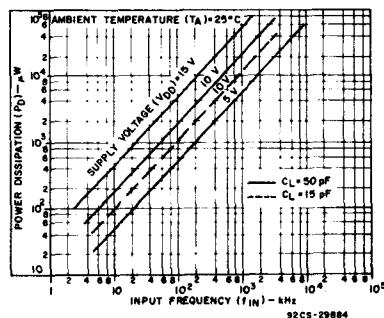


Fig. 7 – Propagation delay time as a function of load capacitance.

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DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS			UNITS
		Min.	Typ.	Max.	
Propagation Delay Time; t_{PLH}, t_{PHL}	$V_{DD} = 5, 10, 15 \text{ V}$	5	—	150	ns
		10	—	60	ns
		15	—	50	ns
Transition Time; t_{THL}, t_{TLH}	$V_{DD} = 5, 10, 15 \text{ V}$	5	—	100	ns
		10	—	50	ns
		15	—	40	ns
Input Capacitance, C_{IN}	All A and B Inputs	—	5	7.5	pF
	K_a and K_b Inputs	—	10	15	pF



NOTE:
MEASURE INPUTS SEQUENTIALLY,
TO BOTH V_{DD} AND V_{SS} .
CONNECT ALL UNUSED
INPUTS TO EITHER
 V_{DD} OR V_{SS} .

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Fig. 9 – Dynamic power dissipation test circuit.

Fig. 10 – Quiescent device current test circuit.

Fig. 11 – Input voltage test circuit.

Fig. 12 – Input current test circuit.

TYPICAL APPLICATIONS

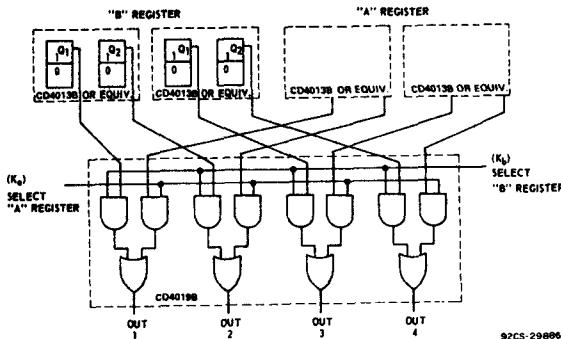


Fig. 13 – AND/OR select gating.

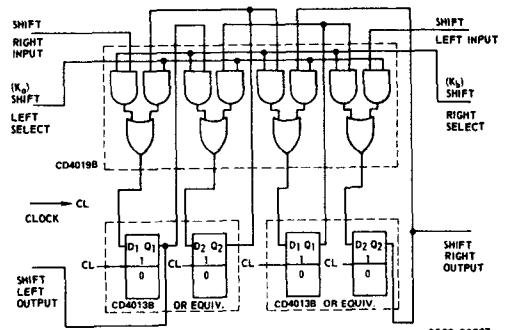


Fig. 14 – "Shift left/shift right" register.

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TYPICAL APPLICATIONS (CONT'D)

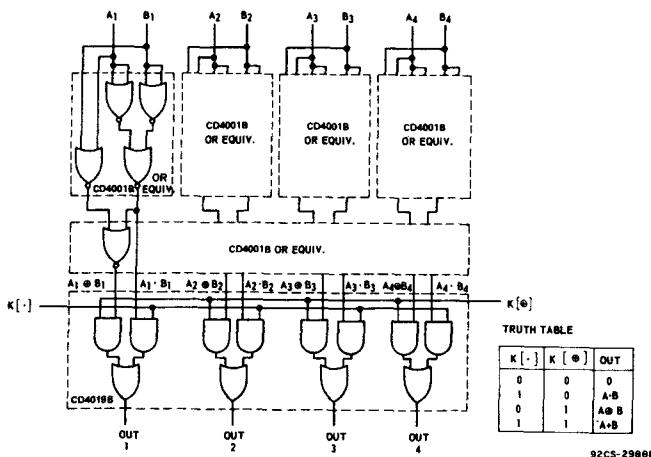


Fig. 15 – AND/OR Exclusive-OR selector.

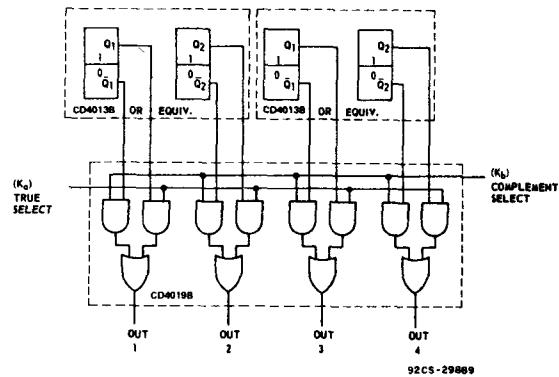
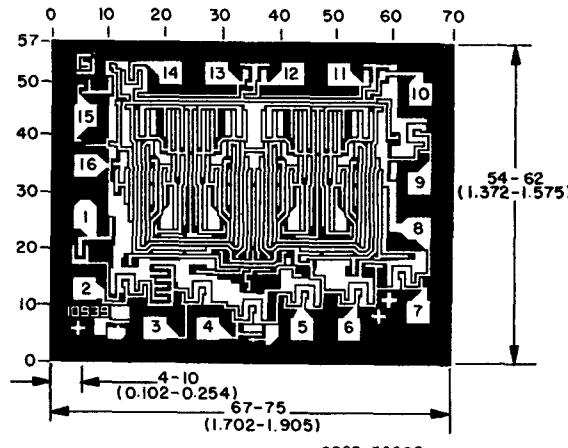


Fig. 16 – "True complement" selector.



Dimensions and pad layout for CD4019BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

The photographs and dimensions of each CMOS chip represent a chip when it is part of the wafer. When the wafer is separated into individual chips, the angle of cleavage may vary with respect to the chip face for different chips. The actual dimensions of the isolated chip, therefore, may differ slightly from the nominal dimensions shown. The user should consider a tolerance of ± 3 mils to ± 16 mils applicable to the nominal dimensions shown.